

## N-Channel 30-V (D-S) MOSFET

PRODUCT SUMMARY				
V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (Ω)	$R_{DS(on)}$ (Ω) $I_{D}$ (A) <sup>a</sup>		
30	0.008 at V <sub>GS</sub> = 10 V	13	6.1 nC	
30	0.011 at V <sub>GS</sub> = 4.5 V	11	0.1110	

SO-8

Top View

8 D

D

6 D

5 D

S

S

S

G

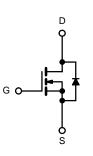
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#### FEATURES

- Halogen-free
- TrenchFET<sup>®</sup> Power MOSFET
- Optimized for High-Side Synchronous Rectifier Operation
- 100 % R<sub>g</sub> Tested
- 100 % UIS Tested

#### **APPLICATIONS**

Notebook CPU Core
High-Side Switch



N-Channel MOSFET

<b>ABSOLUTE MAXIMUM RATINGS</b> $T_A = 25 \text{ °C}$ , unless otherwise noted					
Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V <sub>DS</sub>	30	V	
Gate-Source Voltage		V <sub>GS</sub>	± 20		
	T <sub>C</sub> = 25 °C		13		
Continuous Drain Current ( $T_J = 150 \text{ °C}$ )	T <sub>C</sub> = 70 °C	I	10		
Continuous Drain Current $(T_j = 150^{\circ}C)$	T <sub>A</sub> = 25 °C	I <sub>D</sub>	9 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C		7 <sup>b, c</sup>	^	
Pulsed Drain Current		I <sub>DM</sub>	45	— A	
Continuous Source-Drain Diode Current	T <sub>C</sub> = 25 °C	L.	3.7		
	T <sub>A</sub> = 25 °C	I <sub>S</sub> –	2.0 <sup>b, c</sup>		
Single Pulse Avalanche Current		I <sub>AS</sub>	20		
Avalanche Energy	L = 0.1 mH		21	mJ	
	T <sub>C</sub> = 25 °C		4.1		
Maximum Dewar Discipation	T <sub>C</sub> = 70 °C	Pn	2.5	w	
Maximum Power Dissipation	T <sub>A</sub> = 25 °C	- D	2.2 <sup>b, c</sup>	vv	
	T <sub>A</sub> = 70 °C		1.3 <sup>b, c</sup>		
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient <sup>b, d</sup>	t ≤ 10 s	R <sub>thJA</sub>	39	55	°C/W
Maximum Junction-to-Foot (Drain)	Steady State	R <sub>thJF</sub>	25	29	0/11

Notes:

a. Base on T<sub>C</sub> = 25 °C.

b. Surface Mounted on 1" x 1" FR4 board.

c. t = 10 s. d. Maximum under Steady State conditions is 85  $^{\circ}\text{C/W}.$ 





ise noted	Min	<b>T</b>	Merr	11-14	
Test Conditions	Min.	Тур.	Max.	Unit	
		1		<u> </u>	
$V_{GS} = 0 V, I_{D} = 250 \mu A$	30			V	
I <sub>D</sub> = 250 μA		26		mV/°C	
		- 6			
$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	1.0		3.0	V	
$V_{DS}$ = 0 V, $V_{GS}$ = ± 20 V			± 100	nA	
$V_{DS}$ = 30 V, $V_{GS}$ = 0 V			1	μA	
$V_{\rm DS}$ = 30 V, $V_{\rm GS}$ = 0 V, $T_{\rm J}$ = 55 °C			10	μA	
$V_{DS} \ge 5$ V, $V_{GS}$ = 10 V	20			А	
$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 10 \text{ A}$		0.008		Ω	
$V_{GS} = 4.5 \text{ V}, I_{D} = 9 \text{ A}$		0.011			
$V_{DS} = 15 \text{ V}, \text{ I}_{D} = 10 \text{ A}$		50		S	
V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 0 V, f = 1 MHz		800		pF	
		165			
		73			
V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 10 V, I <sub>D</sub> = 10 A		15	23	nC	
		6.8	10.2		
$V_{DS} = 15 \text{ V}, \text{ V}_{GS} = 5 \text{ V}, \text{ I}_{D} = 10 \text{ A}$		2.5			
		2.3			
f = 1 MHz	0.36	1.8	3.6	Ω	
		16	23		
$V_{DD}$ = 15 V, R <sub>I</sub> = 1.4 $\Omega$	-	12	16	-	
$I_D \cong 9 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$		16	22		
	-	10	18		
		8	16	ns	
$V_{DD}$ = 15 V, $R_L$ = 1.4 $\Omega$		10	20	1	
$I_D \cong 9 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$		16	22	-	
		8	15		
		I			
T <sub>C</sub> = 25 °C			10		
			50	A	
I <sub>S</sub> = 9 A		0.8	1.2	V	
$ \begin{array}{c c} V_{SD} & I_S = 9 \text{ A} \\ \hline t_{rr} & \\ \hline Q_{rr} & \\ \hline t_a & \\ \hline t_b & \end{array} \  \  I_F = 9 \text{ A, dI/dt} = 100 \text{ A/}\mu\text{s, } T_J = 25 \text{ °C} \\ \end{array} $		15	30	ns	
				nC	
				ns	
_	= 9 A, dl/dt = 100 A/µs, T <sub>J</sub> = 25 °C	= 9 A, dl/dt = 100 A/µs, T <sub>J</sub> = 25 °C	6	= 9 A, dl/dt = 100 A/µs, T <sub>J</sub> = 25 °C	

Notes:

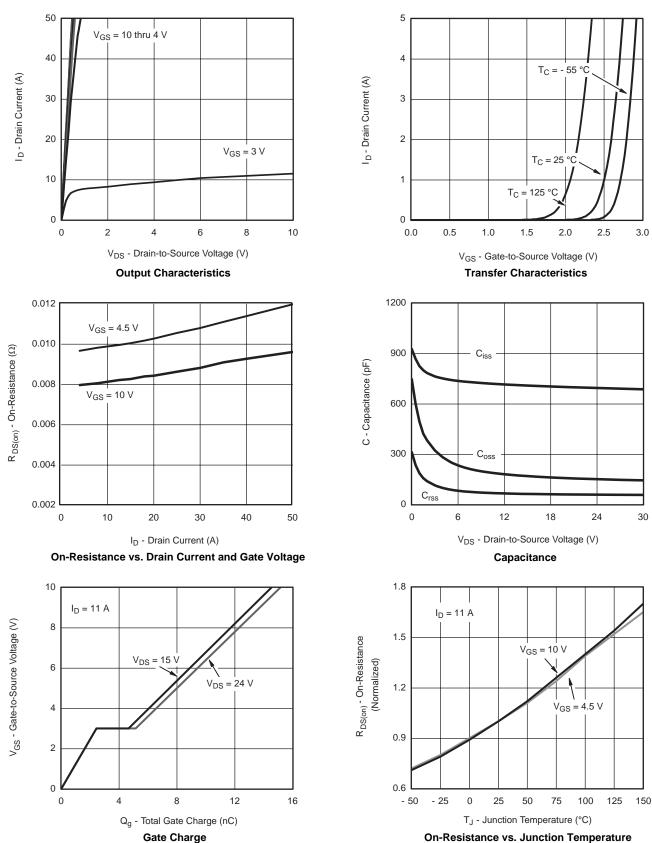
a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %.

b. Guaranteed by design, not subject to production testing.

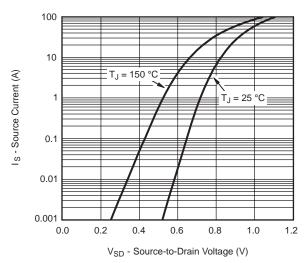
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



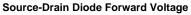


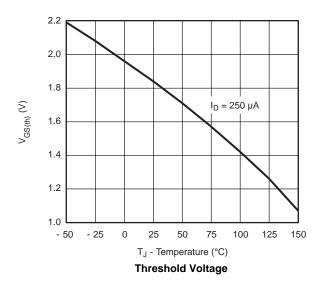


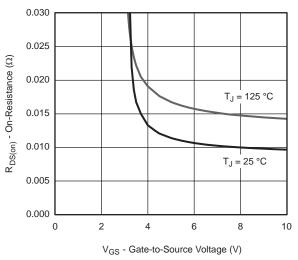




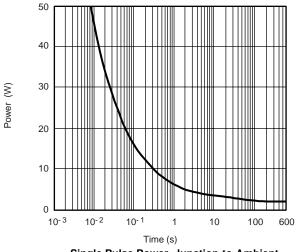
#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



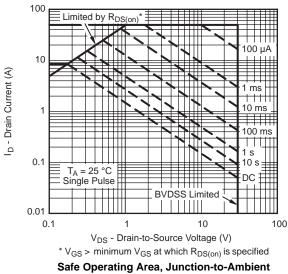




On-Resistance vs. Gate-to-Source Voltage

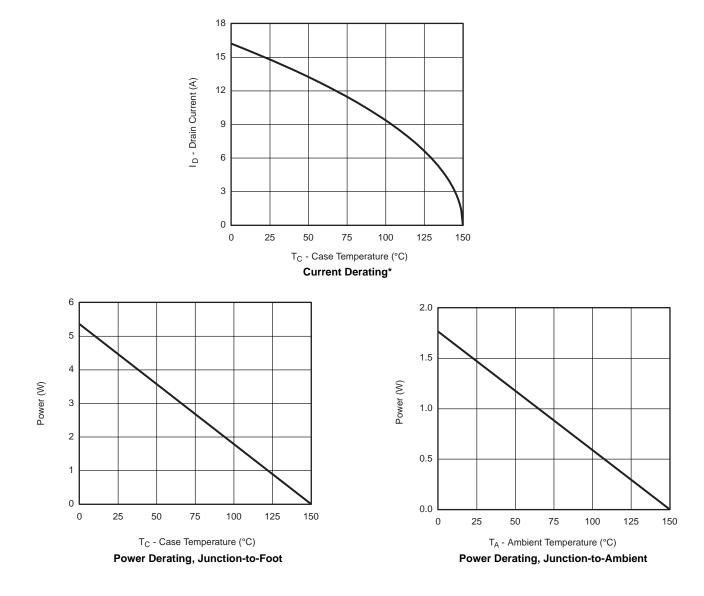






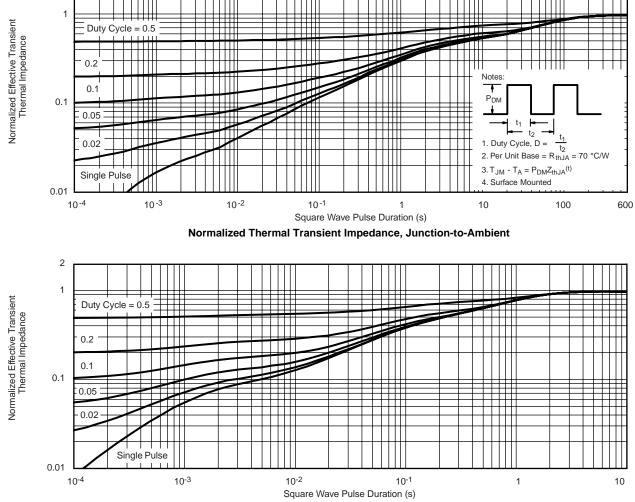


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\* The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

Normalized Thermal Transient Impedance, Junction-to-Foot

<u>VBsemi</u> www.VBsemi.com



### SOIC (NARROW): 8-LEAD





	MILLIMETERS		INC	HES	
DIM	Min	Мах	Min	Max	
A	1.35	1.75	0.053	0.069	
A <sub>1</sub>	0.10	0.20	0.004	0.008	
В	0.35	0.51	0.014	0.020	
С	0.19	0.25	0.0075	0.010	
D	4.80	5.00	0.189	0.196	
E	3.80	4.00	0.150	0.157	
е	1.27 BSC		0.050 BSC		
Н	5.80	6.20	0.228	0.244	
h	0.25	0.50	0.010	0.020	
L	0.50	0.93	0.020	0.037	
q	0°	8°	0°	8°	
S	0.44	0.64	0.018	0.026	
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498					



**RECOMMENDED MINIMUM PADS FOR SO-8** 



Recommended Minimum Pads Dimensions in Inches/(mm)



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